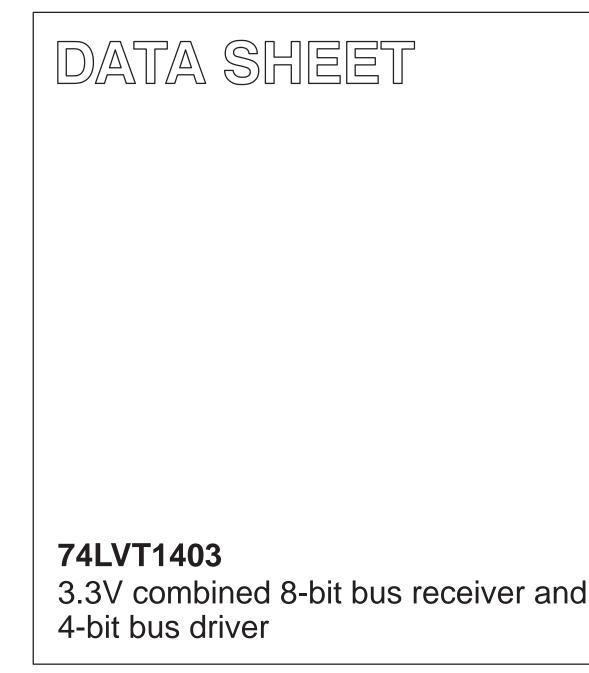
INTEGRATED CIRCUITS



Product specification

1998 Nov 12

IC23 Data Handbook



Semiconductors

Philips

74LVT1403

FEATURES

- 4-bit 74LVT125-like bus driver
- 8-bit 74LVT14-like Schmitt trigger
- Bus drive +64mA/–32mA
- 7 bus inputs with common inversion control pin
- 32-pin TSSOP footprint
- DE pin with resistive pull up and active LOW for easier live insertion
- DE pin includes Schmitt trigger with typical 0.6V hysteresis

DESCRIPTION

The 74LVT1403 is a high-performance BiCMOS product designed for V_{CC} operation at 3.3V.

This device combines the functionality of a 4-bit data path bus driver and 8-bit Schmitt trigger bus receiver, along with control logic in one 32-pin package.

The receiver inputs are Schmitt trigger type capable of transforming slowly changing input signals into sharply defined, jitter-free output signals. The receiver outputs are 74LVT14 style with +32mA/–20mA drive capability. The receiver inputs include the bus hold feature.

The driver outputs feature power-up in 3-State/live insertion capability and are all controlled by the A/B, EN1, and EN2 control pins. The driver inputs include the bus hold feature.

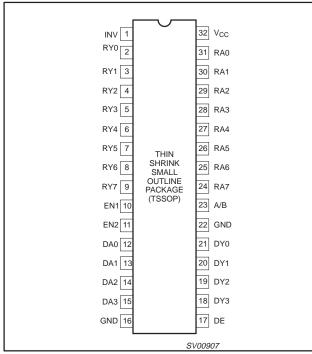
QUICK REFERENCE DATA

SYMBOL	PARAMETER CONDITIONS T _{amb} = 25°C; GND = 0V		TYPICAL	UNIT
t _{PLH}	Propagation delay An to Yn	$C_{L} = 50 pF; V_{CC} = 3.3 V$	4.5	ns
t _{PHL}	Propagation delay An to Yn	$C_{L} = 50 pF; V_{CC} = 3.3 V$	4.0	ns
C _{IN}	Input capacitance	V _I = 0V or 3.0V	3	pF
Icc	Total supply current	Outputs low, $V_{CC} = 3.6V$	4	mA

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
32-pin plastic TSSOP	–40°C to +85°C	74LVT1403 DR	74LVT1403 DR	SOT487-1

PIN CONFIGURATION

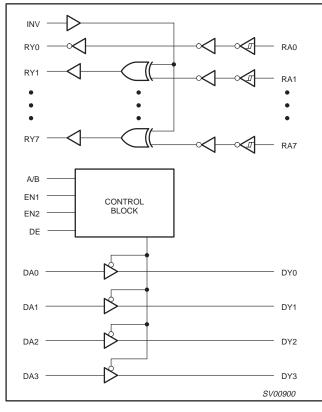


PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION			
31, 30, 29, 28, 27, 26, 25, 24	RA0–RA7	Receive Data inputs			
2, 3, 4, 5, 6, 7, 8, 9	RY0–RY7	Receive Data outputs			
12, 13, 14, 15	DA0–DA3	Driver Data inputs			
21, 20, 19, 18	DY0–DY3	Driver Data outputs			
10, 11	EN1, EN2	Driver Output enables			
23	A/B	Mode control for en- ables			
1	INV	Inversion control			
16, 22	GND	Ground (0V)			
32	V _{CC}	Positive supply voltage			
17	DE	Driver output enable ac- tive LOW with resistive pull up			

74LVT1403

LOGIC SYMBOL



FUNCTION TABLE – RECEIVER

INP	JTS	OUTF	PUTS
RA0-RA7	INV	RY0	RY1–RY7
L	Х	Н	—
Н	Х	L	—
L	L	—	L
Н	L	—	Н
L	Н	_	Н
Н	Н	_	L

H = High voltage level

L = Low voltage level

Don't care Х =

--- = Reported on different line

FUNCTION TABLE – DRIVER

	CONTROL INPUTS			OUTPUT CONDITION
DE	A/B	EN1	EN2	DY Status
L	L	L	L	А
L	L	Х	Н	Z
L	L	Н	Х	Z
L	Н	Н	Н	A
L	Н	Х	L	Z
L	Н	L	Х	Z
Н	Х	Х	Х	Z

High voltage levelLow voltage level Н

L

X = Don't careZ = High imped

= High impedance "off" state

А = Active

DATA PATH IN ACTIVE MODE

INPUT	OUTPUT
DAn	DYn
L	L
Н	Н

74LVT1403

ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +4.6	V
VI	DC input voltage ³		-0.5 to +7.0	V
V _{OUT}	DC output voltage ³	Output in Off or High state	-0.5 to +7.0	V
	DYn DC output current	Output in Low state	128	mA
		Output in High state	-64	mA
OUT		Output in Low state	-32	mA
	RYn DC output current	Output in High state	64	mA
I _{IK}	DC input diode current	V ₁ < 0	-50	mA
I _{OK}	DC output diode current	V _O < 0	-50	mA
T _{stg}	Storage temperature range		-65 to +150	°C

NOTES:

 Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.

3. The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

CYMDOL	OL PARAMETER			IITS	LINUT
SYMBOL	MBOL PARAMETER				UNIT
V _{CC}	DC supply voltage		2.7	3.6	V
VI	Input voltage		0	5.5	V
V _{IH}	High-level input voltage	2.0		V	
V _{IL}	Low-level Input voltage			0.8	V
1	11 sh level esteril come of	DYn		-32	mA
ЮН	High-level output current RYn			-20	mA
		DYn		32	mA
I _{OL}	Low-level output current	RYn		32	mA
	Low-level output current; current duty cycle \leq 50%, f \geq 1kHz DYn			64	mA
$\Delta t / \Delta V$	Input transition rise or fall rate; Outputs enabled			10	ns/V
T _{amb}	Operating free-air temperature range	-40	+85	°C	

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DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0V).

						LIMITS			
SYMBOL	SYMBOL PARAMETER		PARAMETER TEST CONDITIONS		Temp	= -40°C to +	85°C		
				MIN	TYP ¹	MAX			
V _{T+}	Positive-going threshold	RAn	V _{CC} = 3.3V		1.5	1.7	2.0	V	
V _{T-}	Negative-going threshold	RAn	V _{CC} = 3.3V		0.9	1.1	1.3	V	
ΔV_T	Hysteresis	RAn	V _{CC} = 3.3V		0.4	0.6		V	
VIK	Input clamp voltage		V _{CC} = 2.7V; I _{IK} = -18mA				-1.2	V	
			$V_{CC} = 2.7$ to 3.6V; $I_{OH} = -10$	0μΑ	V _{CC} -0.2			V	
		RYn	V _{CC} = 2.7V; I _{OH} = -6mA		2.4			V	
N/	High-level output		V _{CC} = 3.0V; I _{OH} = -20mA		2.0			V	
V _{OH}	voltage		$V_{CC} = 2.7$ to 3.6V; $I_{OH} = -10$	00μΑ	V _{CC} -0.2	V _{CC} -0.1		V	
		DYn	V _{CC} = 2.7V; I _{OH} = -8mA		2.4	2.5		V	
			$V_{CC} = 3.0V; I_{OH} = -32mA$		2.0	2.2		V	
			$V_{CC} = 2.7V; I_{OL} = 100\mu A$				0.2	V	
		RYn	$V_{CC} = 2.7V; I_{OL} = 24mA$				0.5	V	
			V _{CC} = 3.0V; I _{OL} = 32mA				0.5	V	
V.	l ow-level output voltage	$V_{CC} = 2.7V; I_{OL} = 100\mu A$			0.1	0.2	V		
VOL	V _{OL} Low-level output voltage		V _{CC} = 2.7V; I _{OL} = 24mA			0.3	0.5	V	
		DYn	$V_{CC} = 3.0V; I_{OL} = 16mA$			0.25	0.4	V	
			V _{CC} = 3.0V; I _{OL} = 32mA			0.3	0.5	V	
			V _{CC} = 3.0V; I _{OL} = 64mA			0.4	0.55	V	
	· · · · ·		$V_{CC} = 0 \text{ or } 3.6 \text{V}; \text{ V}_{\text{I}} = 5.5 \text{V}$	All inputs		1	10		
			$V_{CC} = 3.6V; V_I = V_{CC}$	Control pins		±0.1	±1		
łı	Input leakage current		V _{CC} = 3.6V; V _I = GND	INV, EN1, EN2, A/B		±0.1	±1	μA	
Ч	input leakage current		$V_{CC} = 5.0V, V_{T} = 0.0D$	DE		-60	-100]	
			$V_{CC} = 3.6V; V_I = V_{CC}$	Data port ⁴		0.1	1		
			$V_{CC} = 3.6V; V_{I} = GND$	Data port		-1	-5	μA	
I _{OFF}	Output off current		$V_{CC} = 0V; V_{I} \text{ or } V_{O} = 0 \text{ to } 4.5$	5V		1	±100	μΑ	
I _{HOLD}	Bus hold current RA and I	DA	$V_{CC} = 3V; V_{I} = 0.8V$		75	150		μΑ	
HOLD	inputs		$V_{CC} = 3V; V_{I} = 2.0V$		-75	-150		μΑ	
I_{EX}	Current into an output in the High state when V _O > V _{CO}		$V_{O} = 5.5V; V_{CC} = 3.0V$			60	125	μA	
I _{PU/PD}	Power-up/down 3-State or current ³	utput	$V_{CC} \le 1.2V$; $V_O = 0.5V$ to V_{CC} ; $V_I = GND$ or V_{CC} ; EN1, EN2, A/B, DE = Don't care			±1	±100	μA	
I _{OZH}	3-State output high currer	ıt	$V_{CC} = 3.6V; V_{O} = 3.0V$			1	5	μA	
I _{OZL}	3-State output low current		$V_{CC} = 3.6V; V_{O} = 0.5V$			-1	-5	μA	
I _{ССН}				√ _{CC} , I _O = 0		0.13	0.19	mA	
I _{CCL}	Quiescent supply current		$V_{CC} = 3.6V;$ Outputs Low, $V_I = GND$ or V			4	11	mA	
I _{CCZ}			V _{CC} = 3.6V; Outputs Disabled, V _I = GND	or V_{CC} , $I_O = 0^5$		0.13	0.19	mA	
ΔI_{CC}	Additional supply current pinput pin ²	ber	V_{CC} = 3V to 3.6V; One input Other inputs at V_{CC} or GND	t at V _{CC} –0.6V,		0.1	0.2	mA	

NOTES:

1. All typical values are at $V_{CC} = 3.3V$ and $T_{amb} = 25^{\circ}C$. 2. This is the increase in supply current for each input at the specified voltage level other than V_{CC} or GND. 3. This parameter is valid for any V_{CC} between 0V and 1.2V with a transition time of up to 10msec. From $V_{CC} = 1.2V$ to $V_{CC} = 3.3V \pm 0.3V$, a transition time of 100 μ sec is permitted. This parameter is valid for T_{amb} = 25°C only.

4. Unused pins at V_{CC} or GND.

5. All RYn outputs High. All DYn outputs pulled up to V_{CC} or pulled down to ground.

74LVT1403

Product specification

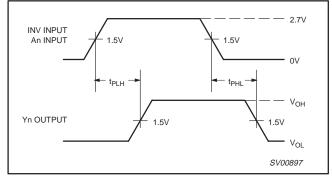
AC CHARACTERISTICS

RAn = Receive inputs; Ryn = Receive outputs DAn = Driver inputs; Dyn = Driver outputs

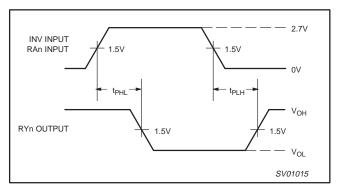
SYMBOL	PARAMETER	WAVEFORM	V _{CO}	$_{ m C}$ = 3.3V \pm 0	.3V	V _{CC} = 2.7V	UNIT
			MIN	TYP	MAX	MAX	
t _{PLH} t _{PHL}	Propagation delay RA0 to RY0	2	1.0 1.0	3.8 3.2	5.7 4.4	6.9 4.3	ns
t _{PLH} t _{PHL}	Propagation delay RAn to RYn (n = 1 to 7)	1, 2	2.0 2.0	4.5 4.0	6.7 5.7	7.8 6.4	ns
t _{PLH} t _{PHL}	Propagation delay Invert to RYn	1, 2	2.0 2.0	4.0 3.6	6.3 5.5	7.1 7.4	ns
t _{PLH} t _{PHL}	Propagation delay DAn to DYn	1	1.0 1.0	3.1 2.0	4.2 3.0	4.7 3.5	ns
t _{PZH} t _{PZL}	Output enable time ENn to DYn with $A/B = 0$	3	2.0 2.0	4.8 4.3	7.1 6.7	9.6 7.4	ns
t _{PZH} t _{PZL}	Output enable time ENn to DYn with $A/B = 1$	4	2.0 2.0	4.3 4.0	6.5 6.1	7.8 6.6	ns
t _{PHZ} t _{PLZ}	Output disable time ENn to DYn with A/B =0	3	2.0 2.0	4.7 4.0	7.1 6.3	8.2 6.9	ns
t _{PHZ} t _{PLZ}	Output disable time ENn to DYn with A/B =1	4	2.0 2.0	4.2 4.0	6.8 6.2	8.3 6.5	ns
t _{PZH} t _{PZL}	Output enable time A/B to DYn	3, 4	2.0 2.0	5.0 4.2	8.6 6.5	9.5 7.2	ns
t _{PHZ} t _{PLZ}	Output disable time A/B to DYn	3, 4	2.0 2.0	5.1 4.3	7.5 6.2	7.7 6.6	ns
t _{PZH} t _{PZL}	Output enable time DE to DYn	3	2.0 2.0	5.1 4.7	7.6 6.8	9.1 7.5	ns
t _{PHZ} t _{PLZ}	Output disable time DE to DYn	3	2.0 2.0	5.9 4.9	9.3 7.2	9.7 7.7	ns

AC WAVEFORMS

 V_{M} = 1.5V, V_{IN} = GND to 2.7V



Waveform 1. Input (An) to Output (Yn) Propagation Delays



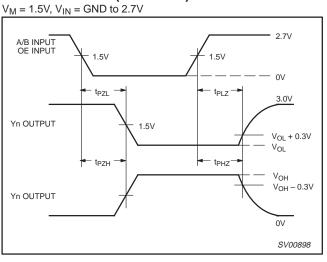
Waveform 2. Input (An) to Output (Yn) Propagation Delays

Product specification

SV00092

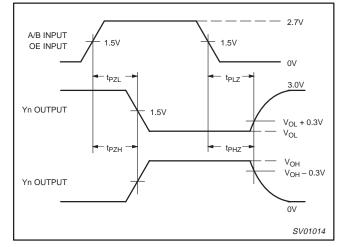
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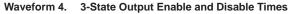
AC WAVEFORMS (Continued)

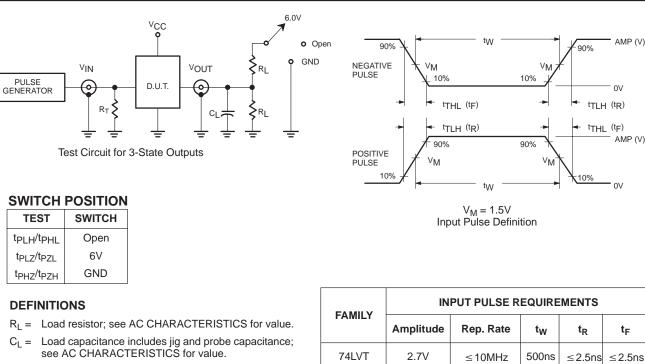


Waveform 3. 3-State Output Enable and Disable Times

TEST CIRCUIT AND WAVEFORM

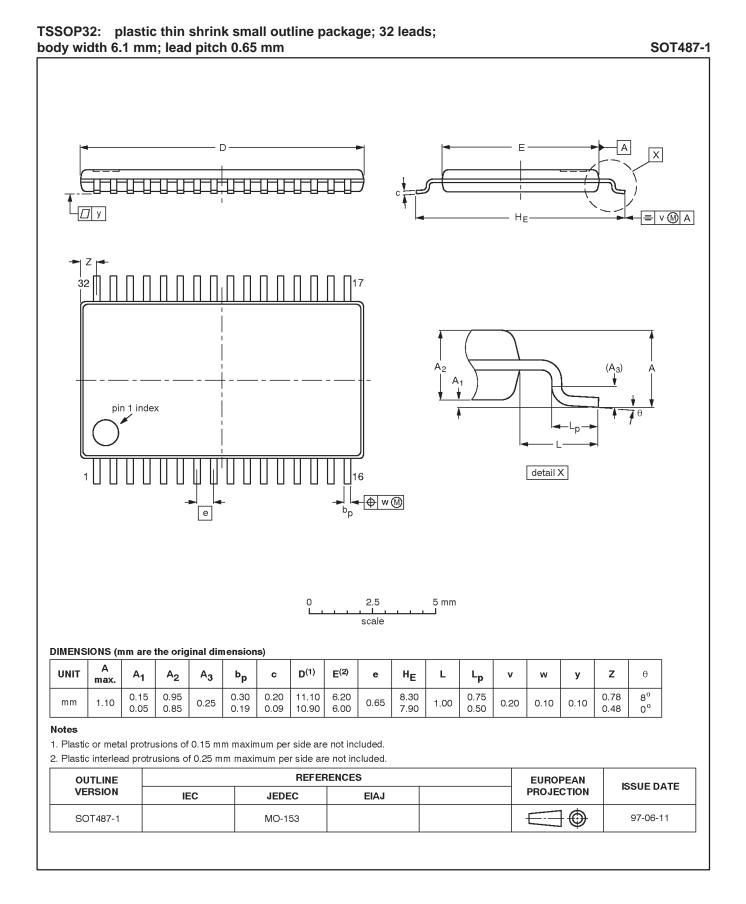






 $\label{eq:RT} R_T = \begin{tabular}{ll} Termination resistance should be equal to Z_{OUT} of pulse generators. \end{tabular}$

74LVT1403



74LVT1403

NOTES

Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
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